

3A, 1000V Low Profile Surface Mount Fast Recovery Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



SMAF





MECHANICAL DATA

Case: SMAF

Molding compound: UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Indicated by cathode band **Weight:** 0.06 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)				
PARAMETER	SYMBOL	RS3MAF	UNIT	
Maximum repetitive peak reverse voltage	V_{RRM}	1000	V	
Maximum RMS voltage	V_{RMS}	700	V	
Maximum DC blocking voltage	V _{DC}	1000	V	
Maximum average forward rectified current	I _{F(AV)}	3	A	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	90	А	
Maximum instantaneous forward voltage (Note 1) @ 3A	V _F	1.3	V	
Maximum reverse current @ reted V	I _R	5	μА	
Maximum reverse current @ rated V_R $T_J=125$ C		250		
Maximum reverse recovery time (Note 2)	t _{rr}	160	ns	
Typical junction capacitance (Note 3)	CJ	30	pF	
T. winel the small vesistance	$R_{ heta JL}$	16	°C/W	
Typical thermal resistance	$R_{\theta JA}$	60		
Operating junction temperature range	T _J	- 55 to +150	°C	
Storage temperature range	T _{STG}	- 55 to +150	°C	
Note 4. Dulas tost with DW-200 as 40/ duty avala				

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Test conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and applied reverse voltage of 4.0V



ORDERING INFORMATION					
PART NO. PACKING CODE PACKING COL		PACKING CODE SUFFIX	PACKAGE	PACKING	
RS3MAF	R3	G	SMAF	3,000 / 7" Plastic reel	
(Note 1)	R2	G	SMAF	10,000 / 13" Paper reel	

Note 1: Whole series with green compound

EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
RS3MAF R3G	RS3MAF	R3	G	Green compound

RATINGS AND CHARACTERISTICS CURVES (T_A=25°C unless otherwise noted)



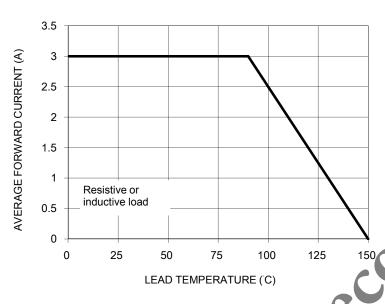


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

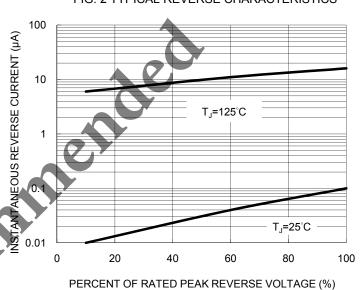


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD

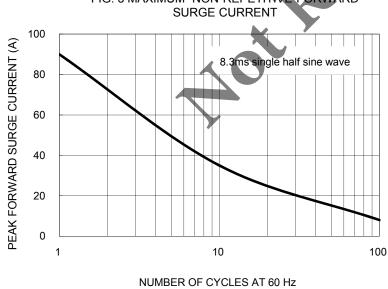
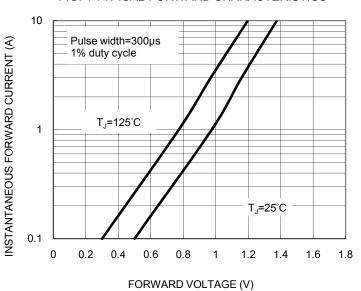
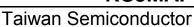


FIG. 4 TYPICAL FORWARD CHARACTERISTICS







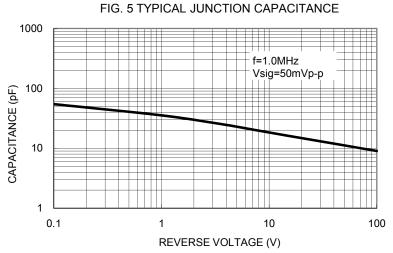
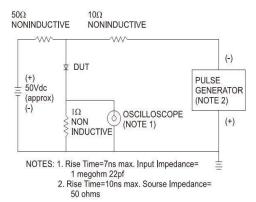
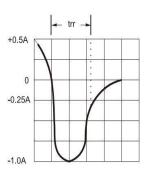


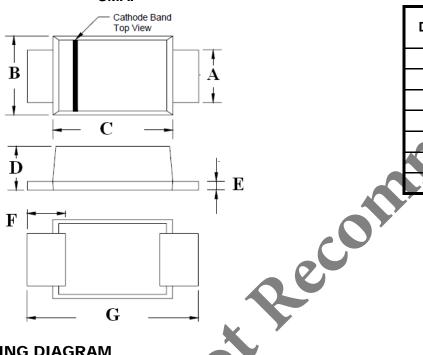
FIG.6 REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





PACKAGE OUTLINE DIMENSIONS

SMAF



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
Α	1.25	1.60	0.049	0.063
В	2.40	2.80	0.094	0.110
C	3.30	4.30	0.130	0.169
О	0.90	1.10	0.035	0.043
T.	0.10	0.25	0.004	0.010
F	0.70	1.20	0.028	0.047
G	4.40	5.20	0.173	0.205

MARKING DIAGRAM



Specific Device Code P/N ≠ G = Green Compound YW =

Date Code F = **Factory Code**



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